

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT3705282

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT
NATURE OF CONVEYANCE:	Corrective Assignment to correct the SCHEDULE A OF THE SECOND LIEN INTELLECTUAL PROPERTY COLLATERAL AGREEMENT previously recorded on Reel 037248 Frame 0539. Assignor(s) hereby confirms the SECURITY INTEREST.
CONVEYING PARTY DATA	
Name	Execution Date
ABACO SYSTEMS HOLDING CORP.	12/07/2015
ABACO SYSTEMS, INC.	12/07/2015
RECEIVING PARTY DATA	
Name:	CORTLAND CAPITAL MARKET SERVICES LLC, AS COLLATERAL AGENT
Street Address:	225 W. WASHINGTON STREET
Internal Address:	21ST FLOOR
City:	CHICAGO
State/Country:	ILLINOIS
Postal Code:	60606
PROPERTY NUMBERS Total: 14	
Property Type	Number
Patent Number:	7679916
Patent Number:	7462043
Patent Number:	6157651
Patent Number:	8233279
Patent Number:	8498127
Patent Number:	8482929
Application Number:	13750078
Patent Number:	7312992
Patent Number:	7746081
Patent Number:	8134842
Patent Number:	6032212
Patent Number:	8091224
Patent Number:	8286009
Patent Number:	8300424
CORRESPONDENCE DATA	

Fax Number: (310)557-2193

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 310-557-2900

Email: klathrop@proskauer.com

Correspondent Name: PROSKAUER ROSE LLP

Address Line 1: 2049 CENTURY PARK EAST, SUITE 3200

Address Line 2: C/O KIMBERLEY A. LATHROP

Address Line 4: LOS ANGELES, CALIFORNIA 90067

ATTORNEY DOCKET NUMBER:	43082.050
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NAME OF SUBMITTER:	KIMBERLEY A. LATHROP
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SIGNATURE:	/Kimberley A. Lathrop/
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DATE SIGNED:	01/21/2016
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Total Attachments: 19

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PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	SECURITY INTEREST
CONVEYING PARTY DATA	
Name	Execution Date
ABACO SYSTEMS HOLDING CORP.	12/07/2015
ABACO SYSTEMS, INC.	12/07/2015
RECEIVING PARTY DATA	
Name:	CORTLAND CAPITAL MARKET SERVICES LLC, AS COLLATERAL AGENT
Street Address:	225 W. WASHINGTON STREET
Internal Address:	21ST FLOOR
City:	CHICAGO
State/Country:	ILLINOIS
Postal Code:	60606
PROPERTY NUMBERS Total: 7	
Property Type	Number
Patent Number:	7679916
Patent Number:	7462043
Patent Number:	6157651
Patent Number:	8233279
Patent Number:	8498127
Patent Number:	8482929
Application Number:	13750078
CORRESPONDENCE DATA	
Fax Number:	(310)557-2193
Phone:	310-557-2900
Email:	klathrop@proskauer.com
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Correspondent Name:	PROSKAUER ROSE LLP
Address Line 1:	2049 CENTURY PARK EAST, SUITE 3200

Address Line 2: C/O KIMBERLEY A. LATHROP	
Address Line 4: LOS ANGELES, CALIFORNIA 90067	
ATTORNEY DOCKET NUMBER:	43082.050
NAME OF SUBMITTER:	KIMBERLEY A. LATHROP
Signature:	/Kimberley A. Lathrop/
Date:	12/09/2015
Total Attachments: 8 source=Second Lien IP Collateral Agreement - patents & trademarks#page1.tif source=Second Lien IP Collateral Agreement - patents & trademarks#page2.tif source=Second Lien IP Collateral Agreement - patents & trademarks#page3.tif source=Second Lien IP Collateral Agreement - patents & trademarks#page4.tif source=Second Lien IP Collateral Agreement - patents & trademarks#page5.tif source=Second Lien IP Collateral Agreement - patents & trademarks#page6.tif source=Second Lien IP Collateral Agreement - patents & trademarks#page7.tif source=Second Lien IP Collateral Agreement - patents & trademarks#page8.tif	
RECEIPT INFORMATION	
EPAS ID:	PAT3650145
Receipt Date:	12/09/2015

EXECUTION COPY

Reference is made to the Intercreditor Agreement dated as of December 7, 2015 (as amended, restated, supplemented or otherwise modified from time to time, the "*Intercreditor Agreement*"), among the Borrower, Holdings, the subsidiaries of Holdings from time to time party thereto, Cortland Capital Market Services LLC, as Initial First Priority Representative (as defined therein), Cortland Capital Market Services LLC, as Initial Second Priority Representative (as defined therein), and each additional Representative (as defined therein) from time to time party thereto. Notwithstanding anything herein to the contrary, the priority of the lien and security interest granted to the Collateral Agent, for the benefit of the Secured Parties, pursuant to this Agreement and the exercise of any right or remedy by the Collateral Agent and the other Secured Parties hereunder are subject to the provisions of the Intercreditor Agreement. In the event of any conflict or inconsistency between any of the provisions of the Intercreditor Agreement, this Agreement and the credit agreement to which this Agreement relates (the "*Credit Agreement*") regarding the priority of the lien and security interest granted to the Collateral Agent and the exercise of any right or remedy by the Collateral Agent, the following order of priorities shall apply: (a) the Intercreditor Agreement, (b) the Credit Agreement and (c) this Agreement.

SECOND LIEN INTELLECTUAL PROPERTY COLLATERAL AGREEMENT

This SECOND LIEN INTELLECTUAL PROPERTY COLLATERAL AGREEMENT (this "*IP Collateral Agreement*") dated as of December 7, 2015, is made by Abaco Systems Holding Corp., a Delaware corporation, and Abaco Systems, Inc., a Delaware corporation (the "*Grantors*") in favor of Cortland Capital Market Services LLC, as collateral agent (in such capacity, together with its successors and assigns in such capacity, the "*Collateral Agent*").

WHEREAS, Abaco Systems Holding Corp., a Delaware corporation ("*Holdings*"), VCR Merger Corp., a Delaware corporation and the initial Borrower ("*Merger Sub*") (which, on the Closing Date shall be merged with and into GE Intelligent Platforms Embedded Systems, Inc., to be renamed, on or promptly following the Closing Date, Abaco Systems, Inc., a Delaware corporation (the "*Company*") with the Company surviving such merger as the successor and being referred to herein as the "*Borrower*"), and the lenders from time to time party thereto have entered into a Second Lien Credit Agreement dated as of December 7, 2015 (as amended, supplemented or otherwise modified from time to time, the "*Second Lien Credit Agreement*") with Cortland Capital Market Services LLC, as Administrative Agent and Collateral Agent. Capitalized terms used in this IP Collateral Agreement and not otherwise defined herein have the meanings specified in the Second Lien Guarantee and Collateral Agreement, Second Lien Credit Agreement and Intercreditor Agreements (as defined below), as applicable.

WHEREAS, each Grantor has executed and delivered that certain Second Lien Guarantee and Collateral Agreement dated as of December 7, 2015, among the Grantors and Collateral Agent, among others (as amended, supplemented or otherwise modified from time to time, the "*Second Lien Guarantee and Collateral Agreement*").

WHEREAS, under the terms of the Second Lien Guarantee and Collateral Agreement, each Grantor has granted to the Collateral Agent, for the ratable benefit of the Secured Parties, a security interest in, among other property, certain intellectual property of such Grantor, and has agreed to execute this IP Collateral Agreement for recording with the U.S. Patent and Trademark Office.

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, each Grantor agrees as follows:

SECTION 1. Grant of Security. As security for the payment or performance, as the case may be, in full of the Obligations, each Grantor hereby pledges to the Collateral Agent, its successors and assigns, for the ratable benefit of the Secured Parties, and hereby grants to the Collateral Agent, its successors and assigns, for the ratable benefit of the Secured Parties, a security interest in all right, title or interest in or to any and all of the following assets and properties now owned or at any time hereafter acquired by such Grantor or in which such Grantor now has or at any time in the future may acquire any right, title or interest (collectively, the "*Collateral*"):

- (a) (i) all letters patent of the United States or the equivalent thereof in any other country, all registrations and recordings thereof, and all applications for letters patent of the United States or the equivalent thereof in any other country, including registrations, recordings and pending applications in the United States Patent and Trademark Office (or any successor or any similar offices in any other country) and (ii) all reissues, continuations, divisions, continuations-in-part, renewals or extensions thereof, and the inventions disclosed or claimed therein, including the right to make, use and/or sell the inventions disclosed or claimed therein, in each case, including those set forth in Schedule A hereto (the "*Patents*");
- (b) (i) all trademarks, service marks, trade names, corporate names, company names, business names, fictitious business names, trade styles, trade dress, logos, other source or business identifiers, designs and general intangibles of like nature, now existing or hereafter adopted or acquired, all registrations and recordings thereof, and all registration and recording applications filed in connection therewith, including registrations and registration applications in the United States Patent and Trademark Office (or any successor office) or any similar offices in any State of the United States or any other country or any political subdivision thereof, and all extensions or renewals thereof, (ii) all goodwill associated therewith or symbolized thereby and (iii) all other assets, rights and interests that uniquely reflect or embody such goodwill, in each case, including those set forth in Schedule B hereto (the "*Trademarks*"); and
- (c) to the extent not otherwise included, all Proceeds and products of any and all of the foregoing.

Notwithstanding anything herein to the contrary, in no event shall the Collateral include, and no Grantor shall be deemed to have granted a security interest in, any Excluded Collateral, including any intent-to-use trademark application prior to the filing with, and

acceptance of, the United States Patent and Trademark Office of a "Statement of Use" or "Amendment to Allege Use" with respect thereto pursuant to Section 1(c) or 1(d) of the Lanham Act (15 U.S.C. § 1051 et seq.), to the extent that the grant of a security interest therein would impair the validity or enforceability of such intent-to-use trademark application or the resulting trademark registration under applicable United States federal law.

SECTION 2. [Reserved]

SECTION 3. Recordation. Each Grantor authorizes and requests that the Commissioner for Patents and the Commissioner for Trademarks record this IP Collateral Agreement.

SECTION 4. Execution in Counterparts. This IP Collateral Agreement may be executed in counterparts (and by different parties hereto on different counterparts), each of which shall constitute an original, but all of which when taken together shall constitute a single contract. Delivery of an executed signature page to this IP Collateral Agreement by facsimile transmission or other means of electronic communication shall be as effective as delivery of a manually signed counterpart of this IP Collateral Agreement.

SECTION 5. Grants, Rights and Remedies. This IP Collateral Agreement has been entered into in conjunction with the provisions of the Second Lien Guarantee and Collateral Agreement. Each Grantor does hereby acknowledge and confirm that the grant of the security interest hereunder to, and the rights and remedies of, the Collateral Agent with respect to the Collateral are more fully set forth in the Second Lien Guarantee and Collateral Agreement, the terms and provisions of which are incorporated herein by reference as if fully set forth herein. In the event of any conflict between the terms of this IP Collateral Agreement and the Second Lien Guarantee and Collateral Agreement, the terms of the Second Lien Guarantee and Collateral Agreement shall control.

SECTION 6. Governing Law. This IP Collateral Agreement shall be construed in accordance with and governed by the laws of the State of New York.

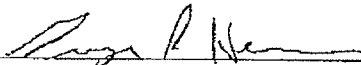
SECTION 7. Intercreditor Agreement Governs. Reference is made to (i) the ABL/Term Intercreditor Agreement dated as of December 7, 2015, among the Borrower, Holdings, the Subsidiaries of Holdings identified therein, the Collateral Agent, the First Lien Collateral Agent and the ABL Collateral Agent (the "***ABL Intercreditor Agreement***") and (ii) the First Lien/Second Lien Intercreditor Agreement dated as of December 7, 2015, among the Borrower, Holdings, the Subsidiaries of Holdings identified therein, the Collateral Agent and the First Lien Collateral Agent (the "***First Lien/Second Lien Intercreditor Agreement***", together with the ABL Intercreditor Agreement, each an "***Intercreditor Agreement***" and collectively the "***Intercreditor Agreements***"). Notwithstanding anything herein to the contrary, the priority of the lien and security interest granted to the Collateral Agent, for the benefit of the Secured Parties, pursuant to this IP Collateral Agreement and the exercise of any right or remedy by the Collateral Agent and the other Secured Parties hereunder are subject to the provisions of the Intercreditor Agreements. In the event of any conflict or inconsistency between any of the provisions of the Intercreditor Agreements, this IP Collateral Agreement and the Second Lien Credit Agreement to which this IP Collateral Agreement relates regarding the priority of the lien

and security interest granted to the Collateral Agent and the exercise of any right or remedy by the Collateral Agent, the following order of priorities shall apply: (a) the applicable Intercreditor Agreement, (b) the Second Lien Credit Agreement and (c) this IP Collateral Agreement.

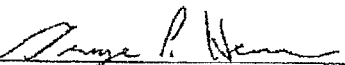
[Remainder of Page Intentionally Blank]

IN WITNESS WHEREOF, the parties hereto have caused this IP Collateral Agreement to be duly executed and delivered by its officer thereunto duly authorized as of the date first above written.

ABACO SYSTEMS HOLDING CORP.

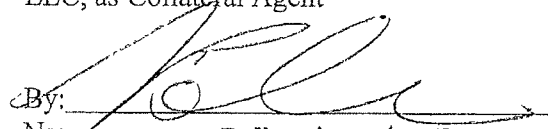
By: 
Name: George Hearn
Title: Executive Vice President and Chief
Financial Officer

ABACO SYSTEMS, INC.

By: 
Name: George Hearn
Title: Executive Vice President and Chief
Financial Officer

[Signature Page to Second Lien Intellectual Property Collateral Agreement]

CORTLAND CAPITAL MARKET SERVICES
LLC, as Collateral Agent

By: 
Name: **Polina Arsentyeva**
Title: **Associate Counsel**

SCHEDULE A

United States Patents and Patent Applications

App Number	Country	Filing Date	Patent Number	Issue Date	Application Title	Owner
11/608384	US	12/8/2006	7679916	3/16/2010	Method And System For Extracting Heat From Electrical Components	GE Intelligent Platforms Embedded Systems, Inc.
11/611586	US	12/15/2006	7462043	12/9/2008	Electrical Connector Element	GE Intelligent Platforms Embedded Systems, Inc.
09/063612	US	4/21/1998	6157651	12/5/2000	Rogue Data Packet Removal Method And Apparatus	GE Intelligent Platforms Embedded Systems, Inc.
12/939208	US	11/4/2010	8233279	7/31/2012	Wedge Lock For Use With A Single Board Computer And Method Of Assembling A Computer System	GE Intelligent Platforms, Inc.
12/879766	US	9/10/2010	8498127	7/30/2013	Thermal Interface Material For Reducing Thermal Resistance And Method Of Making The Same	GE Fanuc Intelligent Platforms, Inc.
13/109253	US	5/17/2011	8482929	7/9/2013	Systems For Circuit Board Heat Transfer And Method Of Assembling Same	General Electric Company
13/750078	US	1/25/2013			Flexible Metallic Heat Connector	General Electric Company

SCHEDULE B**United States Trademark Registrations and Applications**

App Number	Country	Filing Date	Registration Number	Registration Date	Trademark	Owner
76424558	US	6/24/2002	2751497	8/12/2003	CORE-1553	GE Intelligent Platforms Embedded Systems, Inc.
78642382	US	6/2/2005	3209718	2/13/2007	FLIGHTCORE	GE Intelligent Platforms Embedded Systems, Inc.
77136688	US	3/21/2007	3437233	5/27/2008	NETERNITY	GE Intelligent Platforms Embedded Systems, Inc.
77144122	US	3/29/2007	3463501	7/8/2008	OPENWARE	GE Intelligent Platforms Embedded Systems, Inc.
75015083	US	11/6/1995	2017447	11/19/1996	SBS TECHNOLOGIES	GE Intelligent Platforms Embedded Systems, Inc.
103010	US State - AL	8/28/1986	103010	8/28/2006	VMIC AND DESIGN	GE Intelligent Platforms Embedded Systems, Inc.
74020479	US	1/19/1990	1661491	10/22/1991	RADSTONE	GE Intelligent Platforms Embedded Systems, Inc.

EXECUTION COPY

Reference is made to the Intercreditor Agreement dated as of December 7, 2015 (as amended, restated, supplemented or otherwise modified from time to time, the "*Intercreditor Agreement*"), among the Borrower, Holdings, the subsidiaries of Holdings from time to time party thereto, Cortland Capital Market Services LLC, as Initial First Priority Representative (as defined therein), Cortland Capital Market Services LLC, as Initial Second Priority Representative (as defined therein), and each additional Representative (as defined therein) from time to time party thereto. Notwithstanding anything herein to the contrary, the priority of the lien and security interest granted to the Collateral Agent, for the benefit of the Secured Parties, pursuant to this Agreement and the exercise of any right or remedy by the Collateral Agent and the other Secured Parties hereunder are subject to the provisions of the Intercreditor Agreement. In the event of any conflict or inconsistency between any of the provisions of the Intercreditor Agreement, this Agreement and the credit agreement to which this Agreement relates (the "*Credit Agreement*") regarding the priority of the lien and security interest granted to the Collateral Agent and the exercise of any right or remedy by the Collateral Agent, the following order of priorities shall apply: (a) the Intercreditor Agreement, (b) the Credit Agreement and (c) this Agreement.

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WHEREAS, Abaco Systems Holding Corp., a Delaware corporation ("*Holdings*"), VCR Merger Corp., a Delaware corporation and the initial Borrower ("*Merger Sub*") (which, on the Closing Date shall be merged with and into GE Intelligent Platforms Embedded Systems, Inc., to be renamed, on or promptly following the Closing Date, Abaco Systems, Inc., a Delaware corporation (the "*Company*") with the Company surviving such merger as the successor and being referred to herein as the "*Borrower*"), and the lenders from time to time party thereto have entered into a Second Lien Credit Agreement dated as of December 7, 2015 (as amended, supplemented or otherwise modified from time to time, the "*Second Lien Credit Agreement*") with Cortland Capital Market Services LLC, as Administrative Agent and Collateral Agent. Capitalized terms used in this IP Collateral Agreement and not otherwise defined herein have the meanings specified in the Second Lien Guarantee and Collateral Agreement, Second Lien Credit Agreement and Intercreditor Agreements (as defined below), as applicable.

WHEREAS, each Grantor has executed and delivered that certain Second Lien Guarantee and Collateral Agreement dated as of December 7, 2015, among the Grantors and Collateral Agent, among others (as amended, supplemented or otherwise modified from time to time, the "*Second Lien Guarantee and Collateral Agreement*").

WHEREAS, under the terms of the Second Lien Guarantee and Collateral Agreement, each Grantor has granted to the Collateral Agent, for the ratable benefit of the Secured Parties, a security interest in, among other property, certain intellectual property of such Grantor, and has agreed to execute this IP Collateral Agreement for recording with the U.S. Patent and Trademark Office.

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, each Grantor agrees as follows:

SECTION 1. Grant of Security. As security for the payment or performance, as the case may be, in full of the Obligations, each Grantor hereby pledges to the Collateral Agent, its successors and assigns, for the ratable benefit of the Secured Parties, and hereby grants to the Collateral Agent, its successors and assigns, for the ratable benefit of the Secured Parties, a security interest in all right, title or interest in or to any and all of the following assets and properties now owned or at any time hereafter acquired by such Grantor or in which such Grantor now has or at any time in the future may acquire any right, title or interest (collectively, the "*Collateral*"):

- (a) (i) all letters patent of the United States or the equivalent thereof in any other country, all registrations and recordings thereof, and all applications for letters patent of the United States or the equivalent thereof in any other country, including registrations, recordings and pending applications in the United States Patent and Trademark Office (or any successor or any similar offices in any other country) and (ii) all reissues, continuations, divisions, continuations-in-part, renewals or extensions thereof, and the inventions disclosed or claimed therein, including the right to make, use and/or sell the inventions disclosed or claimed therein, in each case, including those set forth in Schedule A hereto (the "*Patents*");
- (b) (i) all trademarks, service marks, trade names, corporate names, company names, business names, fictitious business names, trade styles, trade dress, logos, other source or business identifiers, designs and general intangibles of like nature, now existing or hereafter adopted or acquired, all registrations and recordings thereof, and all registration and recording applications filed in connection therewith, including registrations and registration applications in the United States Patent and Trademark Office (or any successor office) or any similar offices in any State of the United States or any other country or any political subdivision thereof, and all extensions or renewals thereof, (ii) all goodwill associated therewith or symbolized thereby and (iii) all other assets, rights and interests that uniquely reflect or embody such goodwill, in each case, including those set forth in Schedule B hereto (the "*Trademarks*"); and
- (c) to the extent not otherwise included, all Proceeds and products of any and all of the foregoing.

Notwithstanding anything herein to the contrary, in no event shall the Collateral include, and no Grantor shall be deemed to have granted a security interest in, any Excluded Collateral, including any intent-to-use trademark application prior to the filing with, and

acceptance of, the United States Patent and Trademark Office of a "Statement of Use" or "Amendment to Allege Use" with respect thereto pursuant to Section 1(c) or 1(d) of the Lanham Act (15 U.S.C. § 1051 et seq.), to the extent that the grant of a security interest therein would impair the validity or enforceability of such intent-to-use trademark application or the resulting trademark registration under applicable United States federal law.

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SECTION 4. Execution in Counterparts. This IP Collateral Agreement may be executed in counterparts (and by different parties hereto on different counterparts), each of which shall constitute an original, but all of which when taken together shall constitute a single contract. Delivery of an executed signature page to this IP Collateral Agreement by facsimile transmission or other means of electronic communication shall be as effective as delivery of a manually signed counterpart of this IP Collateral Agreement.

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SECTION 6. Governing Law. This IP Collateral Agreement shall be construed in accordance with and governed by the laws of the State of New York.

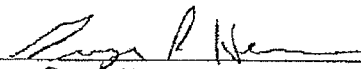
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and security interest granted to the Collateral Agent and the exercise of any right or remedy by the Collateral Agent, the following order of priorities shall apply: (a) the applicable Intercreditor Agreement, (b) the Second Lien Credit Agreement and (c) this IP Collateral Agreement.

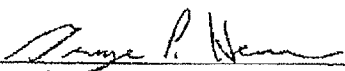
[Remainder of Page Intentionally Blank]

IN WITNESS WHEREOF, the parties hereto have caused this IP Collateral Agreement to be duly executed and delivered by its officer thereunto duly authorized as of the date first above written.

ABACO SYSTEMS HOLDING CORP.

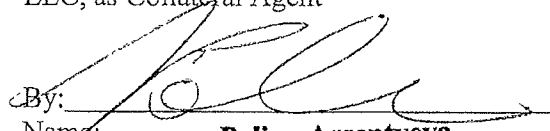
By: 
Name: George Hearn
Title: Executive Vice President and Chief
Financial Officer

ABACO SYSTEMS, INC.

By: 
Name: George Hearn
Title: Executive Vice President and Chief
Financial Officer

[Signature Page to Second Lien Intellectual Property Collateral Agreement]

CORTLAND CAPITAL MARKET SERVICES
LLC, as Collateral Agent

By: 
Name: **Polina Arsentyeva**
Title: **Associate Counsel**

SCHEDULE A

United States Patents and Patent Applications

App Number	Country	Filing Date	Patent Number	Issue Date	Application Title	Owner
11/608384	US	12/8/2006	7679916	3/16/2010	Method And System For Extracting Heat From Electrical Components	Abaco Systems, Inc.
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09/063612	US	4/21/1998	6157651	12/5/2000	Rogue Data Packet Removal Method And Apparatus	Abaco Systems, Inc.
12/939208	US	11/4/2010	8233279	7/31/2012	Wedge Lock For Use With A Single Board Computer And Method Of Assembling A Computer System	Abaco Systems, Inc.
12/879766	US	9/10/2010	8498127	7/30/2013	Thermal Interface Material For Reducing Thermal Resistance And Method Of Making The Same	Abaco Systems, Inc.
13/109253	US	5/17/2011	8482929	7/9/2013	Systems For Circuit Board Heat Transfer And Method Of Assembling Same	Abaco Systems, Inc.
13/750078	US	1/25/2013			Flexible Metallic Heat Connector	Abaco Systems, Inc.
10/999725	US	11/30/2004	7312992*	12/25/2007	Apparatus and Method for Transferring Heat from Processors	Abaco Systems, Inc.
11/608410	US	12/8/2006	7746081*	6/29/2010	Cable Detection Method and Apparatus	Abaco Systems, Inc.
11/618235	US	12/29/2006	8134842*	3/13/2012	Systems and Methods for Converting a Computer Rear Transition Input/Output (I/O) to Front Panel I/O	Abaco Systems, Inc.
08/911564	US	8/14/1997	6032212*	2/29/2000	Device and Method for Interfacing PCI and VMEBUS with a Byte Swapping Circuit	Abaco Systems, Inc.
12/246200	US	10/6/2008	8091224*	1/10/2012	A Method for Coupling a Battery within an Embedded System	Abaco Systems, Inc.
12/551116	US	8/31/2009	8286009*	10/9/2012	Computer Including a Carrier Board and Methods of Assembly	Abaco Systems, Inc.
12/277430	US	11/25/2008	8300424*	10/30/2012	Mounting Bracket for use with a Computer and Method of Assembling a Computer	Abaco Systems, Inc.

*The patent may be expired or abandoned.

SCHEDULE B**United States Trademark Registrations and Applications**

App Number	Country	Filing Date	Registration Number	Registration Date	Trademark	Owner
76424558	US	6/24/2002	2751497	8/12/2003	CORE-1553	Abaco Systems, Inc.
78642382	US	6/2/2005	3209718	2/13/2007	FLIGHTCORE	Abaco Systems, Inc.
77136688	US	3/21/2007	3437233	5/27/2008	NETERNITY	Abaco Systems, Inc.
77144122	US	3/29/2007	3463501	7/8/2008	OPENWARE	Abaco Systems, Inc.
75015083	US	11/6/1995	2017447	11/19/1996	SBS TECHNOLOGIES	Abaco Systems, Inc.
103010	US State - AL	8/28/1986	103010	8/28/2006	VMIC AND DESIGN	GE Intelligent Platforms Embedded Systems, Inc.
74020479	US	1/19/1990	1661491	10/22/1991	RADSTONE	Abaco Systems, Inc.

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